# Plastic High Power Silicon PNP Transistor

... designed for use in high power audio amplifiers utilizing complementary or quasi complementary circuits.

• DC Current Gain —

 $h_{FE} = 30 \text{ (Min)} @ I_{C}$ = 2.0 Adc

• BD 808, 810 are complementary with BD 807, 890

#### **MAXIMUM RATINGS**

Rating	Symbol	Туре	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	BD808 BD810	60 80	Vdc
Collector–Base Voltage	V <sub>CBO</sub>	BD808 BD810	70 80	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>		5.0	Vdc
Collector Current	I <sub>C</sub>		10	Adc
Base Current	lΒ		6.0	Adc
Total Device Dissipation T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>		90 720	Watts mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>		-55 to +150	°C

# THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$\theta_{\sf JC}$	1.39	°C/W

# **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Туре	Min	Max	Unit
Collector–Emitter Sustaining Voltage* (I <sub>C</sub> = 0.1 Adc, I <sub>B</sub> = 0)	BV <sub>CEO</sub>	BD808 BD810	60 80	_ _	Vdc
Collector Cutoff Current $(V_{CB} = 70 \text{ Vdc}, I_E = 0)$ $(V_{CB} = 80 \text{ Vdc}, I_E = 0)$	I <sub>CBO</sub>	BD808 BD810		1.0 1.0	mAdc
Emitter Cutoff Current (V <sub>BE</sub> = 5.0 Vdc, I <sub>C</sub> = 0)	I <sub>EBO</sub>		_	2.0	mAdc
DC Current Gain (I <sub>C</sub> = 2.0 A, V <sub>CE</sub> = 2.0 V) (I <sub>C</sub> = 4.0 A, V <sub>CE</sub> = 2.0 V)	h <sub>FE</sub>		30 15		
Collector–Emitter Saturation Voltage* (I <sub>C</sub> = 3.0 Adc, I <sub>B</sub> = 0.3 Adc)	V <sub>CE(sat)</sub>		_	1.1	Vdc
Base–Emitter On Voltage* (I <sub>C</sub> = 4.0 Adc, V <sub>CE</sub> = 2.0 Vdc)	V <sub>BE(on)</sub>		_	1.6	Vdc
Current–Gain Bandwidth Product (I <sub>C</sub> = 1.0 Adc, V <sub>CE</sub> = 10 Vdc, f = 1.0 MHz)	f <sub>T</sub>		1.5	_	MHz

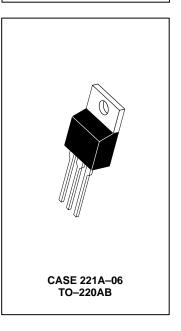
<sup>\*</sup>Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

Preferred devices are ON Semiconductor recommended choices for future use and best overall value.

# BD808 BD810\*

\*ON Semiconductor Preferred Device

10 AMPERE
POWER TRANSISTORS
PNP SILICON
60, 80 VOLTS
90 WATTS



## **BD808 BD810**

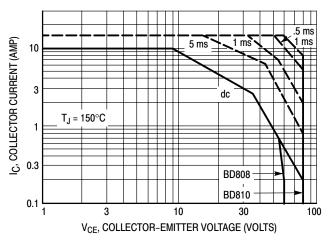


Figure 1. Active Region DC Safe Operating Area (see Note 1)

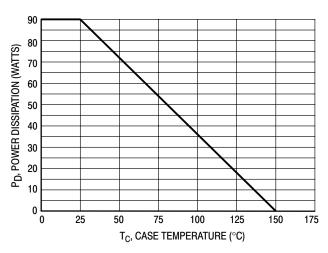


Figure 2. Power-Temperature Derating Curve

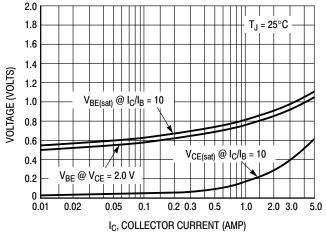


Figure 3. "On" Voltages

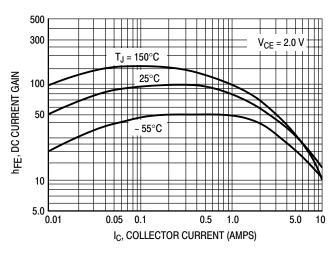


Figure 4. Current Gain

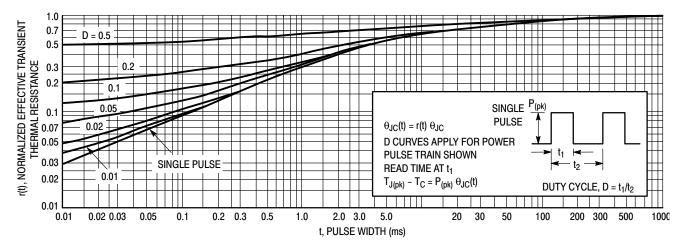


Figure 5. Thermal Response

## **BD808 BD810**

#### Note 1:

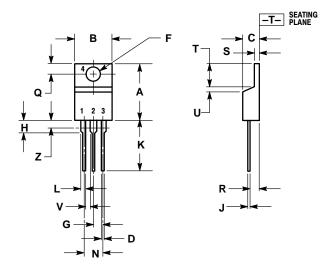
There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C-V_{CE}$  limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 1 is based on  $T_{J(pk)} = 150^{\circ}C$ ;  $T_{C}$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(pk)} \le 150^{\circ}C$ . At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

#### **BD808 BD810**

#### PACKAGE DIMENSIONS

**CASE 221A-06** TO-220AB **ISSUE Y** 



#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.035	0.64	0.88	
F	0.142	0.147	3.61	3.73	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.155	2.80	3.93	
J	0.018	0.025	0.46	0.64	
K	0.500	0.562	12.70	14.27	
٦	0.045	0.060	1.15	1.52	
N	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
T	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
٧	0.045		1.15		
Z		0.080		2.04	

STYLE 1:

PIN 1. BASE

- COLLECTOR 2.
- EMITTER 3.
- COLLECTOR

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